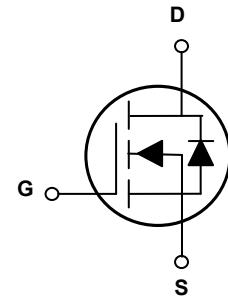
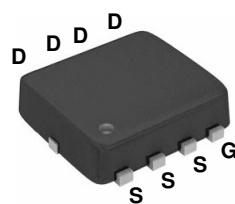


Main Product Characteristics

| | |
|---------------|--------|
| $V_{(BR)DSS}$ | 100V |
| $R_{DS(ON)}$ | 13.6mΩ |
| I_D | 48A |



PPAK3X3

Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The GSFN0982 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Max. | Unit |
|---|-----------------|-------------|------|
| Drain-Source Voltage | V_{DS} | 100 | V |
| Gate-Source Voltage | V_{GS} | +20/-12 | V |
| Drain Current-Continuous($T_C=25^\circ\text{C}$) | I_D | 48 | A |
| Drain Current-Continuous($T_C=100^\circ\text{C}$) | | 30 | |
| Drain Current-Pulsed ¹ | I_{DM} | 192 | A |
| Single Pulse Avalanche Energy ² | E_{AS} | 115 | mJ |
| Single Pulse Avalanche Current ² | I_{AS} | 48 | A |
| Power Dissipation($T_C=25^\circ\text{C}$) | P_D | 61 | W |
| Power Dissipation-Derate above 25°C | | 0.49 | W/°C |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 62 | °C/W |
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 2.04 | °C/W |
| Storage Temperature Range | T_{STG} | -50 To +150 | °C |
| Operating Junction Temperature Range | T_J | -50 To +150 | °C |

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|---|--|--|------|------|------|----------------------------|
| On/Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$ | 100 | - | - | V |
| BV_{DSS} Temperature Coefficient | $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | Reference to 25°C , $I_{\text{D}}=1\text{mA}$ | - | 0.06 | - | $\text{V}/^\circ\text{C}$ |
| Drain-Source Leakage Current | I_{DSS} | $V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$ | - | - | 1 | μA |
| | | $V_{\text{DS}}=80\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$ | - | - | 10 | μA |
| Gate-Source Leakage Current | I_{GSS} | $V_{\text{GS}}=+20\text{V}, V_{\text{DS}}=0\text{V}$ | - | - | 100 | nA |
| Static Drain-Source On-Resistance | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=20\text{A}$ | - | 11.3 | 13.6 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=20\text{A}, T_J=125^\circ\text{C}$ | - | 19 | - | |
| | | $V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=15\text{A}$ | - | 16.7 | 22 | |
| Gate Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250\mu\text{A}$ | 1 | 1.5 | 2.5 | V |
| $V_{\text{GS}(\text{th})}$ Temperature Coefficient | $\Delta V_{\text{GS}(\text{th})}$ | | - | -5.1 | - | $\text{mV}/^\circ\text{C}$ |
| Forward Transconductance | g_{fs} | $V_{\text{DS}}=10\text{V}, I_{\text{D}}=3\text{A}$ | - | 8 | - | S |
| Dynamic and Switching Characteristics | | | | | | |
| Total Gate Charge ^{3,4} | Q_g | $V_{\text{DS}}=50\text{V}, I_{\text{D}}=10\text{A}, V_{\text{GS}}=10\text{V}$ | - | 27.8 | 55 | nC |
| Gate-Source Charge ^{3,4} | Q_{gs} | | - | 3.5 | 7 | |
| Gate-Drain Charge ^{3,4} | Q_{gd} | | - | 8.8 | 17 | |
| Turn-On Delay Time ^{3,4} | $t_{\text{d}(\text{on})}$ | $V_{\text{DD}}=50\text{V}, R_{\text{G}}=6\Omega, V_{\text{GS}}=10\text{V}, I_{\text{D}}=1\text{A}$ | - | 14.2 | 28 | nS |
| Rise Time ^{3,4} | t_r | | - | 20.8 | 42 | |
| Turn-Off Delay Time ^{3,4} | $t_{\text{d}(\text{off})}$ | | - | 42 | 84 | |
| Fall Time ^{3,4} | t_f | | - | 30 | 60 | |
| Input Capacitance | C_{iss} | $V_{\text{DS}}=50\text{V}, V_{\text{GS}}=0\text{V}, F=1\text{MHz}$ | - | 1640 | 3280 | pF |
| Output Capacitance | C_{oss} | | - | 240 | 480 | |
| Reverse Transfer Capacitance | C_{rss} | | - | 4 | 10 | |
| Gate Resistance | R_g | $V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, F=1\text{MHz}$ | - | 1.14 | - | Ω |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| Continuous Source Current | I_s | $V_G=V_D=0\text{V}, \text{Force Current}$ | - | - | 48 | A |
| Pulsed Source Current | I_{SM} | | - | - | 96 | A |
| Diode Forward Voltage | V_{SD} | $V_{\text{GS}}=0\text{V}, I_s=1\text{A}, T_J=25^\circ\text{C}$ | - | - | 1 | V |
| Reverse Recovery Time ³ | t_{rr} | $I_s=10\text{A}, \text{di/dt}=100\text{A}/\mu\text{s}, T_J=25^\circ\text{C}$ | - | 43.5 | - | nS |
| Reverse Recovery Charge ³ | Q_{rr} | | - | 59.6 | - | nC |

Note:

1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
2. $V_{\text{DD}}=50\text{V}, V_{\text{GS}}=10\text{V}, L=0.1\text{mH}, I_{\text{AS}}=48\text{A}, R_{\text{G}}=25\Omega$, Starting $T_J=25^\circ\text{C}$
3. The data tested by pulsed, pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.

Typical Electrical and Thermal Characteristic Curves

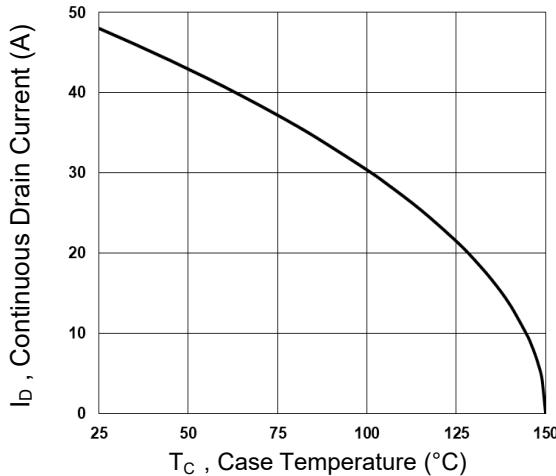


Fig.1 Continuous Drain Current vs. T_c

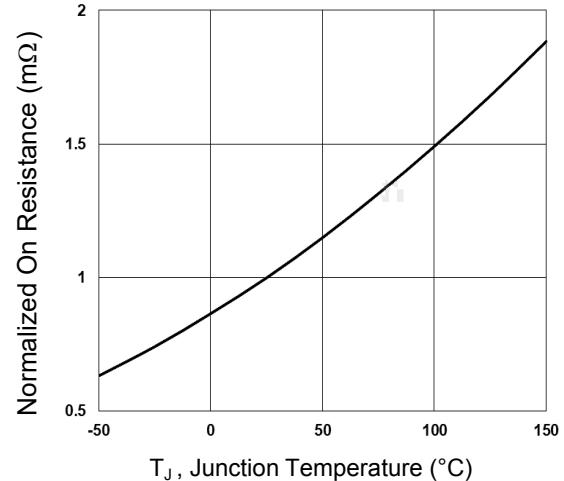


Fig.2 Normalized $R_{DS(ON)}$ vs. T_J

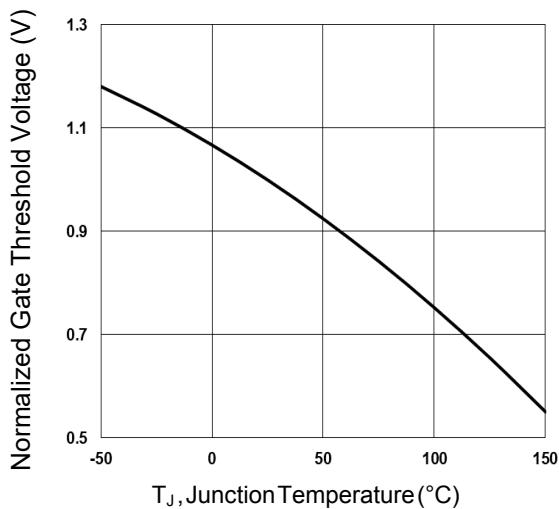


Fig.3 Normalized V_{th} vs. T_J

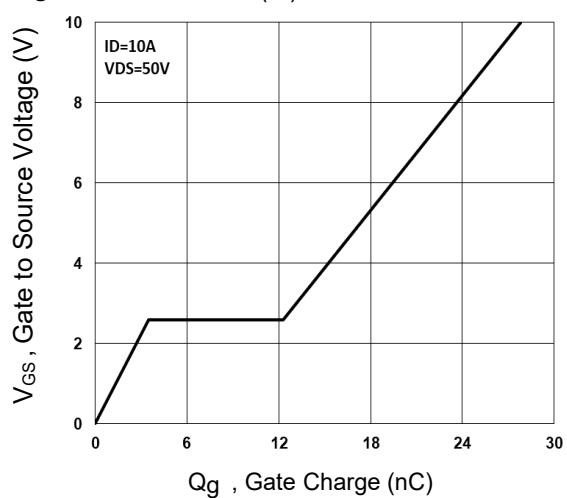


Fig.4 Gate Charge Waveform

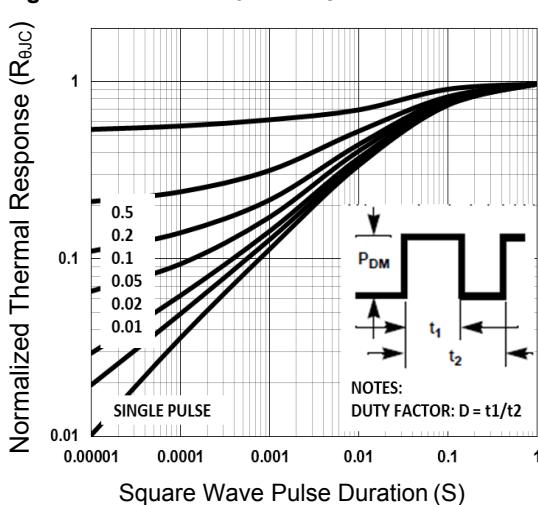


Fig.5 Normalized Transient Impedance

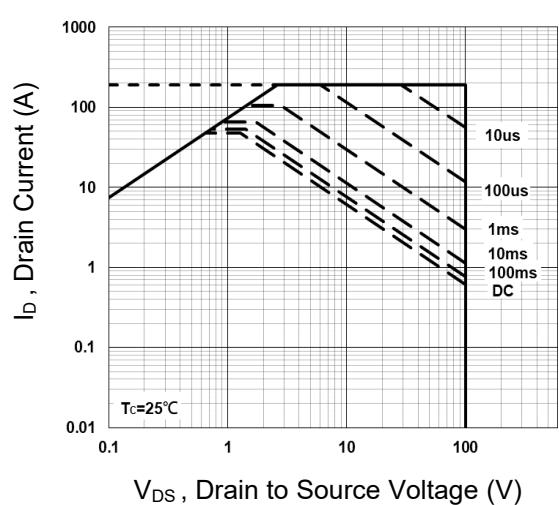


Fig.6 Maximum Safe Operation Area

Typical Electrical and Thermal Characteristic Curves

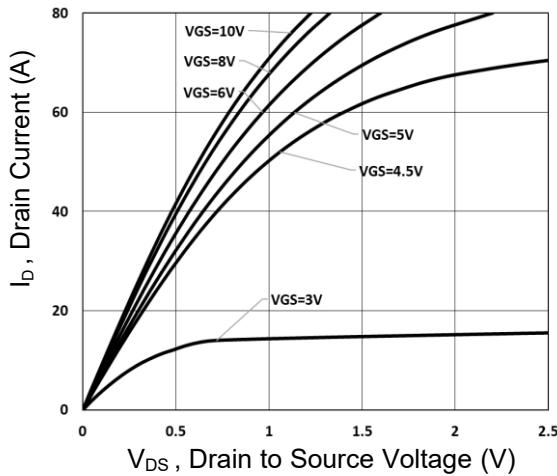


Fig.7 Typical Output Characteristics

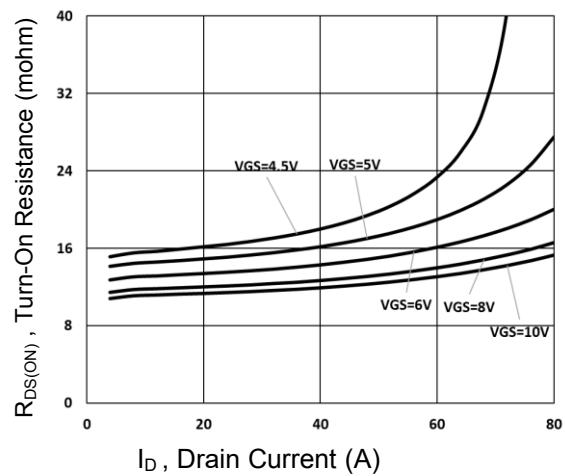


Fig.8 Turn-On Resistance vs. I_D

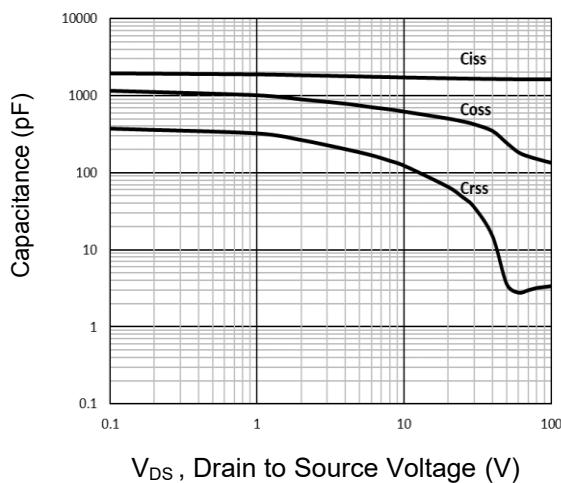


Fig.9 Capacitance Characteristics

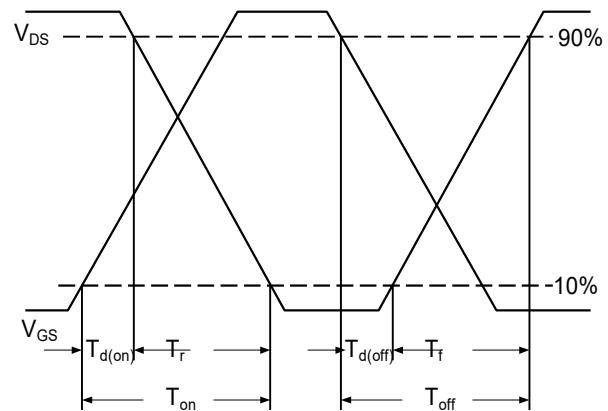


Fig.10 Switching Time Waveform

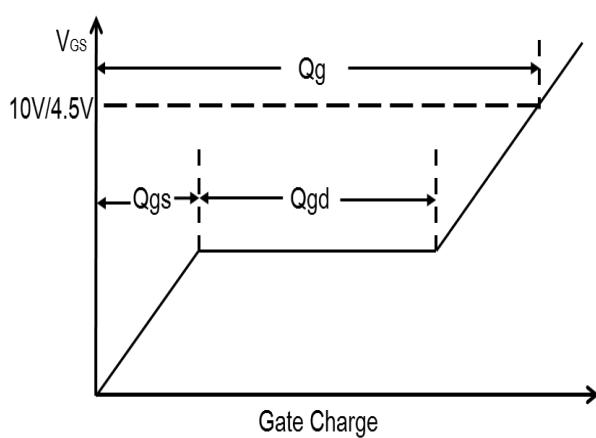
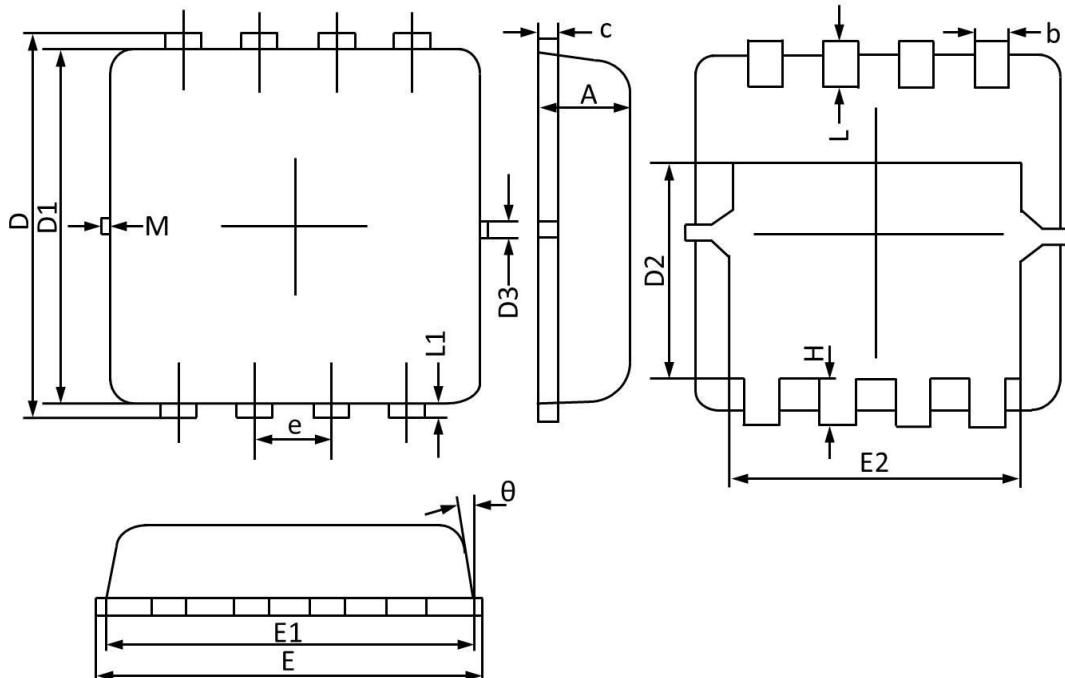


Fig.11 Gate Charge Waveform

Package Outline Dimensions



PPAK3X3

| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 0.700 | 0.800 | 0.028 | 0.031 |
| b | 0.250 | 0.350 | 0.010 | 0.013 |
| c | 0.100 | 0.250 | 0.004 | 0.009 |
| D | 3.250 | 3.450 | 0.128 | 0.135 |
| D1 | 3.000 | 3.200 | 0.119 | 0.125 |
| D2 | 1.780 | 1.980 | 0.070 | 0.077 |
| D3 | 0.130 REF | | 0.005 REF | |
| E | 3.200 | 3.400 | 0.126 | 0.133 |
| E1 | 3.000 | 3.200 | 0.119 | 0.125 |
| E2 | 2.390 | 2.590 | 0.094 | 0.102 |
| e | 0.650 BSC | | 0.026 BSC | |
| H | 0.300 | 0.500 | 0.011 | 0.019 |
| L | 0.300 | 0.500 | 0.011 | 0.019 |
| L1 | 0.130 REF | | 0.005 REF | |
| θ | 0° | 12° | 0° | 12° |
| M | 0.150 REF | | 0.006 REF | |